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# FXLA108

# Low-Voltage Dual-Supply 8-Bit Voltage Translator with Configurable Voltage Supplies and Signal Levels, 3-State Outputs, and Auto Direction Sensing

## Features

- Bi-Directional Interface between Two Levels: from 1.1V to 3.6V

- Fully Configurable: Inputs and Outputs Track $V_{CC}$

- Non-Preferential Power-Up; Either $V_{CC}$ May Be Powered Up First

- Outputs Switch to 3-State if Either $V_{CC}$ is at GND

- Power-Off Protection

- Bus-Hold on Data Inputs Eliminates the Need for Pull-Up Resistors; Do Not Use Pull-Up Resistors on A or B Ports

- Control Input (/OE) Referenced to $V_{CCA}$ Voltage

- Packaged in 20-Terminal DQFN (2.5mm x 4.5mm)

- Direction Control Not Necessary

- 100Mbps Throughput when Translating Between 1.8V and 2.5V

- ESD Protection Exceeds:
  - 8kV HBM
    (per JESD22-A114 &Mil Std 883e 3015.7)
  - 2kV CDM (per ESD STM 5.3)

## Applications

- Laptops, Notebooks,

- Routers, Switches

## Description

The FXLA108 is a configurable dual-voltage supply translator for both uni-directional and bi-directional voltage translation between two logic levels. The device allows translation between voltages as high as 3.6V to as low as 1.1V. The A port tracks the $V_{CCA}$ level and the B port tracks the $V_{CCB}$ level. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2V, 1.5V, 1.8V, 2.5V, and 3.3V.

The device remains in three-state as long as either $V_{CC}=0V$, allowing either $V_{CC}$ to be powered up first. Internal power-down control circuits place the device in 3-state if either $V_{CC}$ is removed.

The /OE input, when HIGH, disables both the A and B ports by placing them in a 3-state condition. The /OE input is supplied by $V_{CCA}$.

The FXLA108 supports bi-directional translation without the need for a direction control pin. The two ports of the device have auto-direction sense capability. Either port may sense an input signal and transfer it as an output signal to the other port.

## Ordering Information

| Part Number | Operating Temperature Range | Package | Packing Method |
|---|---|---|---|
| FXLA108BQX | -40 to 85°C | 20-Terminal DQFN 2.5mm x 4.5mm Package | 3K Units Tape and Reel |

## Pin Configuration
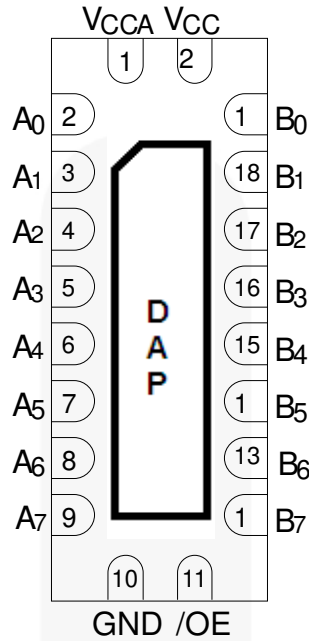


**Figure 1. Pin Configuration (Top Through View)**

## Pin Definitions

| Pin # | Name | Description |
|---|---|---|
| 1 | $V_{CCA}$ | A-Side Power Supply |
| 2 | $A_0$ | A-Side Inputs or 3-State Outputs |
| 3 | $A_1$ | A-Side Inputs or 3-State Outputs |
| 4 | $A_2$ | A-Side Inputs or 3-State Outputs |
| 5 | $A_3$ | A-Side Inputs or 3-State Outputs |
| 6 | $A_4$ | A-Side Inputs or 3-State Outputs |
| 7 | $A_5$ | A-Side Inputs or 3-State Outputs |
| 8 | $A_6$ | A-Side Inputs or 3-State Outputs |
| 9 | $A_7$ | A-Side Inputs or 3-State Outputs |
| 10 | GND | Ground |
| 11 | /OE | Output Enable Input |
| 12 | $B_7$ | B-Side Inputs or 3-State Outputs |
| 13 | $B_6$ | B-Side Inputs or 3-State Outputs |
| 14 | $B_5$ | B-Side Inputs or 3-State Outputs |
| 15 | $B_4$ | B-Side Inputs or 3-State Outputs |
| 16 | $B_3$ | B-Side Inputs or 3-State Outputs |
| 17 | $B_2$ | B-Side Inputs or 3-State Outputs |
| 18 | $B_1$ | B-Side Inputs or 3-State Outputs |
| 19 | $B_0$ | B-Side Inputs or 3-State Outputs |
| 20 | $V_{CCB}$ | B-Side Power Supply |
| DAP | NC | No Connect |

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## Functional Diagram



**Figure 2. Functional Diagram**

## Function Table

| Control | Outputs |
|---|---|
| /OE | |
| LOW Logic Level | Normal Operation |
| HIGH Logic Level | 3-State |

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Conditions | Min. | Max. | Unit |
|--------|-----------|------------|------|------|------|
| $V_{CC}$ | Supply Voltage | $V_{CCA}$ | -0.5 | 4.6 | V |
| | | $V_{CCB}$ | -0.5 | 4.6 | |
| $V_I$ | DC Input Voltage | I/O Ports A and B | -0.5 | 4.6 | V |
| | | Control Input (/OE) | -0.5 | 4.6 | |
| $V_O$ | Output Voltage[2] | Output 3-State | -0.5 | 4.6 | V |
| | | Output Active ($A_n$) | -0.5 | $V_{CCA}$ +0.5 | |
| | | Output Active ($B_n$) | -0.5 | $V_{CCB}$ +0.5 | |
| $I_{IK}$ | DC Input Diode Current | $V_I<0V$ | | -50 | mA |
| $I_{OK}$ | DC Output Diode Current | $V_O<0V$ | | -50 | mA |
| | | $V_O>V_{CC}$ | | +50 | |
| $I_{OH}/I_{OL}$ | DC Output Source/Sink Current | | -50 | +50 | mA |
| $I_{CC}$ | DC $V_{CC}$ or Ground Current (per Supply Pin) | | | ±100 | mA |
| $T_{STG}$ | Storage Temperature Range | | -65 | +150 | °C |
| $P_D$ | Power Dissipation | | | 35 | mW |
| ESD | Human Body Model, JESD22-A114 | | | 8 | kV |
| | Charged Device Model, JESD22-C101 | | | 2 | |

**Notes:**
1. $I_O$ absolute maximum ratings must be observed.
2. All unused inputs and input/outputs must be held at $V_{CCi}$ or GND.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Conditions | Min. | Max. | Unit |
|--------|-----------|------------|------|------|------|
| $V_{CC}$ | Power Supply | Operating $V_{CCA}$ or $V_{CCB}$ | 1.1 | 3.6 | V |
| $V_{IN}$ | Input Voltage | Ports A and B | 0 | 3.6 | V |
| | | Control Input (/OE) | 0 | $V_{CCA}$ | V |
| $T_A$ | Operating Temperature, Free Air | | -40 | +85 | °C |
| dt/dV | Minimum Input Edge Rate | $V_{CCA/B}$ = 1.1 to 3.6V | | 10 | ns/V |
| $\Theta_{JA}$ | Thermal Resistance: Junction-to-Ambient | | | 50 | °C/W |
| $\Theta_{JC}$ | Thermal Resistance: Junction-to-Case | | | 23 | °C/W |

## Power-Up/Power-Down Sequence

FXL translators offer an advantage in that either $V_{CC}$ may be powered up first. This benefit derives from the chip design. When either $V_{CC}$ is at 0V, outputs are in a high-impedance state. The control input (/OE) is designed to track the $V_{CCA}$ supply. A pull-up resistor tying /OE to $V_{CCA}$ should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up or power-down. The size of the pull-up resistor is based upon the current-sinking capability of the device driving the /OE pin.

The recommended power-up sequence is:

1.  Apply power to the first $V_{CC}$.
2.  Apply power to the second $V_{CC}$.
3.  Drive the /OE input LOW to enable the device.

The recommended power-down sequence is:

1.  Drive /OE input HIGH to disable the device.
2.  Remove power from either $V_{CC}$.
3.  Remove power from other $V_{CC.}$

## Pull-Up/Pull-Down Resistors

Do not use pull-up or pull-down resistors. This device has bus-hold circuits: pull-up or pull-down resistors are not recommended because they interfere with the output state. The current through these resistors may exceed the hold drive, $I_{I(HOLD)}$ and/or $I_{I(OD)}$ bus-hold currents. The bus-hold feature eliminates the need for extra resistors.

## DC Electrical Characteristics

$T_A$=-40 to 85°C.

| Symbol | Parameter | Conditions | $V_{CCA}$ (V) | $V_{CCB}$ (V) | Min. | Typ. | Max. | Units |
|--------|-----------|------------|---------------|---------------|------|------|------|-------|
| $V_{IHA}$ | High-Level Input Voltage | Data Inputs $A_n$ Control Pin /OE | 2.70 to 3.60 | 1.10 to 3.60 | 2.00 | | | V |
| | | | 2.30 to 2.70 | | 1.60 | | | |
| | | | 1.65 to 2.30 | | $.65xV_{CCA}$ | | | |
| | | | 1.40 to 1.65 | | $.65xV_{CCA}$ | | | |
| | | | 1.10 to 1.40 | | $.90xV_{CCA}$ | | | |
| $V_{IHB}$ | | Data Inputs $B_n$ | 1.10 to 3.60 | 2.70 to 3.60 | 2.00 | | | V |
| | | | | 2.30 to 2.70 | 1.60 | | | |
| | | | | 1.65 to 2.30 | $.65xV_{CCB}$ | | | |
| | | | | 1.40 to 1.65 | $.65xV_{CCB}$ | | | |
| | | | | 1.10 to 1.40 | $.90xV_{CCB}$ | | | |
| $V_{ILA}$ | Low-Level Input Voltage | Data Inputs $A_n$ Control Pin /OE | 2.70 to 3.60 | 1.10 to 3.60 | | | .80 | V |
| | | | 2.30 to 2.70 | | | | .70 | |
| | | | 1.65 to 2.30 | | | | $.35xV_{CCA}$ | |
| | | | 1.40 to 1.65 | | | | $.35xV_{CCA}$ | |
| | | | 1.10 to 1.40 | | | | $.10xV_{CCA}$ | |
| $V_{ILB}$ | | Data Inputs $B_n$ | 1.10 to 3.60 | 2.70 to 3.60 | | | .80 | V |
| | | | | 2.30 to 2.70 | | | .70 | |
| | | | | 1.65 to 2.30 | | | $.35xV_{CCB}$ | |
| | | | | 1.40 to 1.65 | | | $.35xV_{CCB}$ | |
| | | | | 1.10 to 1.40 | | | $.10xV_{CCB}$ | |
| $V_{OHA}$ | High-Level Output Voltage[3] | $I_{OH}$=-4µA | 1.10 to 3.60 | 1.10 to 3.60 | $V_{CCA}$ - .40 | | | V |
| $V_{OHB}$ | | $I_{OH}$=-4µA | 1.10 to 3.60 | 1.10 to 3.60 | $V_{CCB}$ - .40 | | | |
| $V_{OLA}$ | Low-Level Output Voltage[3] | $I_{OL}$=4µA | 1.10 to 3.60 | 1.10 to 3.60 | | | .4 | V |
| $V_{OLB}$ | | $I_{OL}$=4µA | 1.10 to 3.60 | 1.10 to 3.60 | | | .4 | |
| $I_{I(HOLD)}$ | Bus-Hold Input Minimum Drive Current | $V_{IN}$=0.80V | 3.00 | 3.00 | 75.0 | | | µA |
| | | $V_{IN}$=2.00V | 3.00 | 3.00 | -75.0 | | | |
| | | $V_{IN}$=0.7V | 2.30 | 2.30 | 45.0 | | | |
| | | $V_{IN}$=1.60V | 2.30 | 2.30 | -45.0 | | | |
| | | $V_{IN}$=0.57V | 1.65 | 1.65 | 25.0 | | | |
| | | $V_{IN}$=1.07V | 1.65 | 1.65 | -25.0 | | | |
| | | $V_{IN}$=0.49V | 1.40 | 1.40 | 11.0 | | | |
| | | $V_{IN}$=0.91V | 1.40 | 1.40 | -11.0 | | | |
| | | $V_{IN}$=0.11V | 1.10 | 1.10 | | 4.0 | | |
| | | $V_{IN}$=0.99V | 1.10 | 1.10 | | -4.0 | | |

*Continued on following page…*

## DC Electrical Characteristics (Continued)

$T_A$=-40 to 85°C.

| Symbol | Parameter | Conditions | $V_{CCA}$ (V) | $V_{CCB}$ (V) | Min. | Max. | Units |
|---|---|---|---|---|---|---|---|
| $I_{I(ODH)}$ | Bus-Hold Input Overdrive High Current[4] | Data Inputs $A_n$, $B_n$ | 3.60 | 3.60 | 450.00 | | μA |
| | | | 2.70 | 2.70 | 300.00 | | |
| | | | 1.95 | 1.95 | 200.00 | | |
| | | | 1.60 | 1.60 | 120.00 | | |
| | | | 1.40 | 1.40 | 80.00 | | |
| $I_{I(ODL)}$ | Bus-Hold Input Overdrive Low Current[5] | Data Inputs $A_n$, $B_n$ | 3.60 | 3.60 | -450.00 | | μA |
| | | | 2.70 | 2.70 | -300.00 | | |
| | | | 1.95 | 1.95 | -200.00 | | |
| | | | 1.60 | 1.60 | -120.00 | | |
| | | | 1.40 | 1.40 | -80.00 | | |
| $I_I$ | Input Leakage Current | Control Inputs /OE, $V_I$=$V_{CCA}$ or GND | 1.10 to 3.60 | 3.60 | | ±1.0 | μA |
| $I_{OFF}$ | Power-Off Leakage Current | $A_n$ $V_O$=0V to 3.6V | 0 | 3.6 | | ±2.0 | μA |
| | | $B_n$ $V_O$=0V to 3.6V | 3.60 | 0 | | ±2.0 | |
| $I_{OZ}$ | 3-State Output Leakage | $A_n$, $B_n$ $V_O$=0V or 3.6V, /OE=$V_{IH}$ | 3.6 | 3.60 | | ±5.0 | μA |
| | | $A_n$ $V_O$=0V or 3.6V, /OE=GND | 3.60 | 0 | | ±5.0 | |
| | | $B_n$ $V_O$=0V or 3.6V, /OE=GND | 0 | 3.60 | | ±5.0 | |
| $I_{CCA/B}$ | Quiescent Supply Current[6, 7] | $V_I$=$V_{CCI}$ or GND; $I_O$=0, /OE=GND | 1.10 to 3.60 | 1.10 to 3.60 | | 10.0 | μA |
| $I_{CCZ}$ | | $V_I$=$V_{CCI}$ or GND; $I_O$=0, /OE=$V_{IH}$ | 1.10 to 3.60 | 1.10 to 3.60 | | 10.0 | μA |
| $I_{CCA}$ | Quiescent Supply Current | $V_I$=$V_{CCB}$ or GND; $I_O$=0 B-to-A Direction, /OE=GND | 0 | 1.10 to 3.60 | | -10.0 | μA |
| | | $V_I$=$V_{CCA}$ or GND; $I_O$=0 A-to-B Direction | 1.10 to 3.60 | 0 | | 10.0 | |
| $I_{CCB}$ | | $V_I$=$V_{CCA}$ or GND; $I_O$=0, A-to-B Direction, /OE=GND | 1.10 to 3.60 | 0 | | -10.0 | μA |
| | | $V_I$=$V_{CCB}$ or GND; $I_O$=0 B-to-A Direction | 0 | 1.10 to 3.60 | | 10.0 | |

**Notes:**
3. This is the output voltage for static conditions. Dynamic drive specifications are given in the Dynamic Output Electrical Characteristics table.
4. An external drive must source at least the specified current to switch LOW-to-HIGH.
5. An external drive must source at least the specified current to switch HIGH-to-LOW.
6. $V_{CCI}$ is the $V_{CC}$ associated with the input side.
7. Reflects current per supply, $V_{CCA}$ or $V_{CCB}$.

## Dynamic Output Electrical Characteristic

### A Port ($A_n$)

**Output Load: $C_L$=15pF, $R_L \geq M\Omega$ ($C_{I/O}$=4pF), $T_A$=-40 to 85°C**

| Symbol | Parameter | $V_{CCA}$=3.0V to 3.6V | | $V_{CCA}$=2.3V to 2.7V | | $V_{CCA}$=1.65V to 1.95V | | $V_{CCA}$=1.4V to 1.6V | | $V_{CCA}$=1.1V to 1.3V | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | Typ. | Max. | Typ. | Max. | Typ. | Max | Typ. | Max. | Typ. | |
| $t_{rise}$ | Output Rise Time A Port[9] | | 3.0 | | 3.5 | | 4.0 | | 5.0 | 7.5 | ns |
| $t_{fall}$ | Output Fall Time A Port[10] | | 3.0 | | 3.5 | | 4.0 | | 5.0 | 7.5 | ns |
| $I_{OHD}$ | Dynamic Output Current High[9] | -11.4 | | -7.5 | | -4.7 | | -3.2 | | -1.7 | mA |
| $I_{OLD}$ | Dynamic Output Current Low[10] | +11.4 | | +7.5 | | +4.7 | | +3.2 | | +1.7 | mA |

### B Port ($B_n$)

**Output Load: $C_L$=15pF, $R_L \geq M\Omega$ ($C_{I/O}$=5pF), $T_A$=-40 to 85°C**

| Symbol | Parameter | $V_{CCB}$=3.0V to 3.6V | | $V_{CCB}$=2.3V to 2.7V | | $V_{CCB}$=1.65V to 1.95V | | $V_{CCB}$=1.4V to 1.6V | | $V_{CCB}$=1.1V to 1.3V | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | Typ. | Max. | Typ. | Max. | Typ. | Max | Typ. | Max. | Typ. | |
| $t_{rise}$ | Output Rise Time B Port[9] | | 3.0 | | 3.5 | | 4.0 | | 5.0 | 7.5 | ns |
| $t_{fall}$ | Output Fall Time B Port[10] | | 3.0 | | 3.5 | | 4.0 | | 5.0 | 7.5 | ns |
| $I_{OHD}$ | Dynamic Output Current High[9] | -12.0 | | -7.9 | | -5.0 | | -3.4 | | -1.8 | mA |
| $I_{OLD}$ | Dynamic Output Current Low[10] | +12.0 | | +7.9 | | +5.0 | | +3.4 | | +1.8 | mA |

**Notes:**
8. Dynamic output characteristics are guaranteed, but not tested.
9. *See Figure 7.*
10. *See Figure 8.*

## AC Characteristics

**V$_{CCA}$ = 3.0V to 3.6V, T$_A$=-40 to 85°C**

| Symbol | Parameter | V$_{CCB}$=3.0V to 3.6V | | V$_{CCB}$=2.3V to 2.7V | | V$_{CCB}$=1.65V to 1.95V | | V$_{CCB}$=1.4V to 1.6V | | V$_{CCB}$=1.1V to 1.3V | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | Min. | Max. | Min. | Max. | Min. | Max | Min. | Max. | Typ. | |
| t$_{PLH}$,t$_{PHL}$ | A to B | 0.2 | 4.0 | 0.3 | 4.2 | 0.5 | 5.4 | 0.6 | 6.8 | 6.9 | ns |
| | B to A | 0.2 | 4.0 | 0.2 | 4.1 | 0.3 | 5.0 | 0.5 | 6.0 | 4.5 | ns |
| t$_{PZL}$,t$_{PZH}$ | /OE to A, /OE to B | | 1.7 | | 1.7 | | 1.7 | | 1.7 | 1.7 | µs |
| t$_{SKEW}$ | A Port, B Port[11] | | 0.5 | | 0.5 | | 0.5 | | 1.0 | 1.0 | ns |

**V$_{CCA}$ = 2.3V to 2.7V, T$_A$=-40 to 85°C**

| Symbol | Parameter | V$_{CCB}$=3.0V to 3.6V | | V$_{CCB}$=2.3V to 2.7V | | V$_{CCB}$=1.65V to 1.95V | | V$_{CCB}$=1.4V to 1.6V | | V$_{CCB}$=1.1V to 1.3V | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | Min. | Max. | Min. | Max. | Min. | Max | Min. | Max. | Typ. | |
| t$_{PLH}$,t$_{PHL}$ | A to B | 0.2 | 4.1 | 0.4 | 4.5 | 0.5 | 5.6 | 0.8 | 6.9 | 7.0 | ns |
| | B to A | 0.3 | 4.2 | 0.4 | 4.5 | 0.5 | 5.5 | 0.5 | 6.5 | 4.8 | ns |
| t$_{PZL}$,t$_{PZH}$ | /OE to A, /OE to B | | 1.7 | | 1.7 | | 1.7 | | 1.7 | 1.7 | µs |
| t$_{SKEW}$ | A Port, B Port[11] | | 0.5 | | 0.5 | | 0.5 | | 1.0 | 1.0 | ns |

**V$_{CCA}$ = 1.65V to 1.95V, T$_A$=-40 to 85°C**

| Symbol | Parameter | V$_{CCB}$=3.0V to 3.6V | | V$_{CCB}$=2.3V to 2.7V | | V$_{CCB}$=1.65V to 1.95V | | V$_{CCB}$=1.4V to 1.6V | | V$_{CCB}$=1.1V to 1.3V | Units |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | Min. | Max. | Min. | Max. | Min. | Max | Min. | Max. | Typ. | |
| t$_{PLH}$,t$_{PHL}$ | A to B | 0.3 | 5.0 | 0.5 | 5.5 | 0.8 | 6.7 | 0.9 | 7.5 | 7.5 | ns |
| | B to A | 0.5 | 5.4 | 0.5 | 5.6 | 0.8 | 6.7 | 1.0 | 7.0 | 5.4 | ns |
| t$_{PZL}$,t$_{PZH}$ | /OE to A, /OE to B | | 1.7 | | 1.7 | | 1.7 | | 1.7 | 1.7 | µs |
| t$_{SKEW}$ | A Port, B Port[11] | | 0.5 | | 0.5 | | 0.5 | | 1.0 | 1.0 | ns |

**Note:**
11. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (A$_n$ or B$_n$) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW) *(see Figure 10)*. Skew is guaranteed, but not tested.

## AC Characteristics (Continued)

**V_CCA = 1.4V to 1.6V, T_A=-40 to 85°C**

| Symbol | Parameter | V_CCB=3.0V to 3.6V | | V_CCB=2.3V to 2.7V | | V_CCB=1.65V to 1.95V | | V_CCB=1.4V to 1.6V | | V_CCB=1.1V to 1.3V | Units |
|--------|-----------|------|------|------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max | Min. | Max. | Typ. | |
| $t_{PLH}, t_{PHL}$ | A to B | 0.5 | 6.0 | 0.5 | 6.5 | 1.0 | 7.0 | 1.0 | 8.5 | 7.9 | ns |
| | B to A | 0.6 | 6.8 | 0.8 | 6.9 | 0.9 | 7.5 | 1.0 | 8.5 | 6.1 | ns |
| $t_{PZL}, t_{PZH}$ | /OE to A, /OE to B | | 1.7 | | 1.7 | | 1.7 | | 1.7 | 1.7 | µs |
| $t_{SKEW}$ | A Port, B Port[12] | | 1.0 | | 1.0 | | 1.0 | | 1.0 | 1.0 | ns |

**V_CCA = 1.1V to 1.3V, T_A=-40 to 85°C**

| Symbol | Parameter | V_CCB=3.0V to 3.6V | V_CCB=2.3V to 2.7V | V_CCB=1.65V to 1.95V | V_CCB=1.4V to 1.6V | V_CCB=1.1V to 1.3V | Units |
|--------|-----------|------|------|------|------|------|-------|
| | | Typ. | Typ. | Typ. | Typ. | Typ. | |
| $t_{PLH}, t_{PHL}$ | A to B | 4.6 | 4.8 | 5.4 | 6.2 | 9.2 | ns |
| | B to A | 6.8 | 7.0 | 7.4 | 7.8 | 9.1 | ns |
| $t_{PZL}, t_{PZH}$ | /OE to A, /OE to B | 1.7 | 1.7 | 1.7 | 1.7 | 1.7 | µs |
| $t_{SKEW}$ | A Port, B Port[12] | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | ns |

**Note:**

12. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port ($A_n$ or $B_n$) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW) *(see Figure 10)*. Skew is guaranteed, but not tested.

## Maximum Data Rate

$T_A$=-40 to 85°C.

| $V_{CCA}$ | $V_{CCB}$=3.0V to 3.6V | $V_{CCB}$=2.3V to 2.7V | $V_{CCB}$=1.65V to 1.95V | $V_{CCB}$=1.4V to 1.6V | $V_{CCB}$=1.1V to 1.3V | Units |
|---|---|---|---|---|---|---|
| | Min. | Min. | Min. | Min. | Typ. | |
| $V_{CCA}$=3.00V to 3.60V | 140 | 120 | 100 | 80 | 40 | Mbps |
| $V_{CCA}$=2.30V to 2.70V | 120 | 120 | 100 | 80 | 40 | Mbps |
| $V_{CCA}$=1.65V to 1.95V | 100 | 100 | 80 | 60 | 40 | Mbps |
| $V_{CCA}$=1.40V to 1.60V | 80 | 80 | 60 | 60 | 40 | Mbps |
| $V_{CCA}$=1.10V to 1.30V | Typ. | Typ. | Typ. | Typ. | Typ. | |
| | 40 | 40 | 40 | 40 | 40 | Mbps |

**Notes:**
13. Maximum data rate is guaranteed, but not tested.
14. Maximum data rate is specified in megabits per second *(see Figure 9)*. It is equivalent to two times the F-toggle frequency, specified in megahertz. For example, 100Mbps is equivalent to 50MHz.

## Capacitance

| Symbol | Parameter | | Conditions | $T_A$=+25°C Typical | Units |
|---|---|---|---|---|---|
| $C_{IN}$ | Input Capacitance Control Pin (/OE) | | $V_{CCA}$=$V_{CCB}$=GND | 3 | pF |
| $C_{I/O}$ | Input/Output Capacitance | $A_n$ | $V_{CCA}$=$V_{CCB}$=3.3V, /OE=$V_{CCA}$ | 4 | pF |
| | | $B_n$ | | 5 | |
| $C_{pd}$ | Power Dissipation Capacitance | | $V_{CCA}$=$V_{CCB}$=3.3V, $V_I$=0V or $V_{CC}$, f=10MHz | 25 | pF |

## I/O Architecture Benefit

The FXLA108 I/O architecture benefits the end user, beyond level translation, in the following three ways:

**Auto Direction** without an external direction pin.

**Drive Capacitive Loads**. Automatically shifts to a higher current drive mode only during "Dynamic Mode" or HL / LH transitions.

**Lower Power Consumption**. Automatically shifts to low-power mode during "Static Mode" (no transitions), lowering power consumption.

The FXLA108 does not require a direction pin. Instead, the I/O architecture detects input transitions on both side and automatically transfers the data to the corresponding output. For example, for a given channel, if both A and B side are at a static LOW, the direction has been established as A $\rightarrow$ B, and a LH transition occurs on the B port; the FXLA108 internal I/O architecture automatically changes direction from A $\rightarrow$ B to B $\rightarrow$ A.

During HL / LH transitions, or "Dynamic Mode," a strong output driver drives the output channel in parallel with a weak output driver. After a typical delay of approximately 10ns – 50ns, the strong driver is turned off, leaving the weak driver enabled for holding the logic state of the channel. This weak driver is called the "bus hold." "Static Mode" is when only the bus hold drives the channel. The

bus hold can be over ridden in the event of a direction change. The strong driver allows the FXLA108 to quickly charge and discharge capacitive transmission lines during dynamic mode. Static mode conserves power, where $I_{CC}$ is typically < 5µA.

## Bus Hold Minimum Drive Current

Specifies the minimum amount of current the bus hold driver can source/sink. The bus hold minimum drive current ($II_{HOLD}$) is $V_{CC}$ dependent and guaranteed in the DC Electrical tables. The intent is to maintain a valid output state in a static mode, but that can be overridden when an input data transition occurs.

## Bus Hold Input Overdrive Drive Current

Specifies the minimum amount of current required (by an external device) to overdrive the bus hold in the event of a direction change. The bus hold overdrive ($II_{ODH}$, $I_{IODL}$) is $V_{CC}$ dependent and guaranteed in the DC Electrical tables.

## Dynamic Output Current

The strength of the output driver during LH / HL transitions is *referenced on page 8, Dynamic Output Electrical Characteristics, $I_{OHD}$, and $I_{OLD}$.*
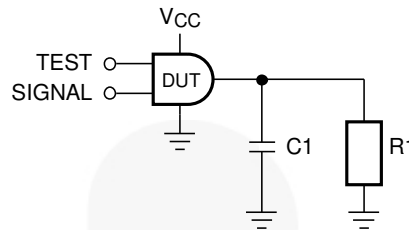
## Test Diagrams



**Figure 3.  Test Circuit**

**Table 1.  AC Test Conditions**

| Test | Input Signal | Output Enable Control |
|---|---|---|
| $t_{PLH}$, $t_{PHL}$ | Data Pulses | 0V |
| $t_{PZL}$ | 0V | HIGH to LOW Switch |
| $t_{PZH}$ | $V_{CCI}$ | HIGH to LOW Switch |

**Table 2.  AC Load**

| $V_{CCo}$ | C1 | R1 |
|---|---|---|
| 1.2V± 0.1V | 15pF | 1MΩ |
| 1.5V± 0.1V | 15pF | 1MΩ |
| 1.8V ± 0.15V | 15pF | 1MΩ |
| 2.5V ± 0.2V | 15pF | 1MΩ |
| 3.3V ± 0.3V | 15pF | 1MΩ |
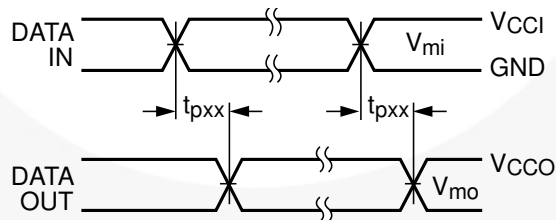


**Figure 4.  Waveform for Inverting and Non-Inverting Functions**

**Notes:**
15.  Input $t_R$ = $t_F$ = 2.0ns, 10% to 90%.
16.  Input $t_R$ = $t_F$ = 2.5ns, 10% to 90%, at $V_I$ = 3.0V to 3.6V only.

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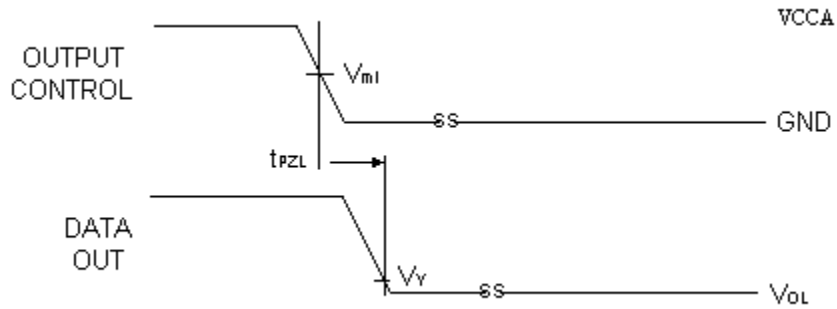
**Figure 5.  3-State Output Low Enable Time for Low Voltage Logic**

**Notes:**
17.  Input $t_R = t_F$ = 2.0ns, 10% to 90%.
18.  Input $t_R = t_F$ = 2.5ns, 10% to 90%, at $V_I$ = 3.0V to 3.6V only.
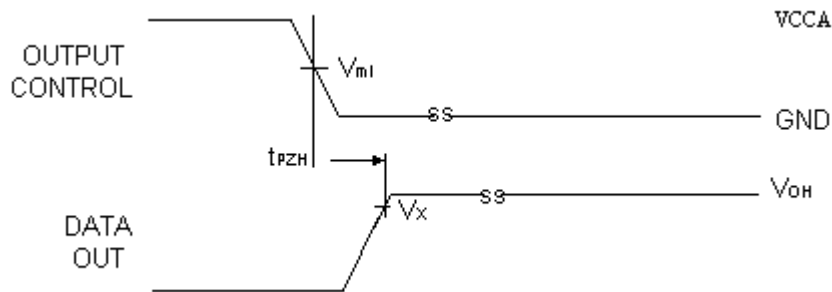


**Figure 6.  3-State Output High Enable Time for Low Voltage Logic**

**Notes:**
19.  Input $t_R = t_F$ = 2.0ns, 10% to 90%.
20.  Input $t_R = t_F$ = 2.5ns, 10% to 90%, at $V_I$ = 3.0V to 3.6V only.

**Table 3.    Test Measure Points**

| Symbol | $V_{DD}$ |
|---|---|
| $V_{MI}$[21] | $V_{CCI}$ /2 |
| $V_{MO}$ | $V_{CCo}$ /2 |
| $V_X$ | 0.9 x $V_{CCo}$ |
| $V_Y$ | 0.1 x $V_{CCo}$ |

**Note:**
21.  $V_{CCI} = V_{CCA}$ for control pin /OE or $V_{MI} = (V_{CCA}/2)$.
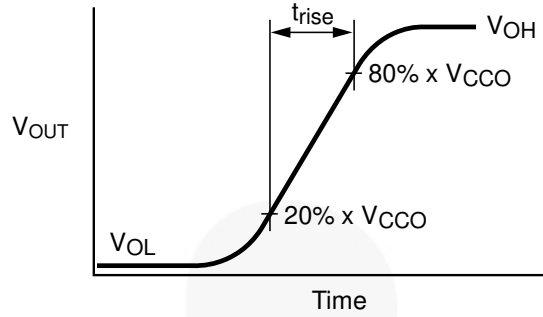
$$I_{OHD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(20\% - 80\%) \bullet V_{CCO}}{t_{RISE}}$$

**Figure 7.  Active Output Rise Time and Dynamic Output Current High**
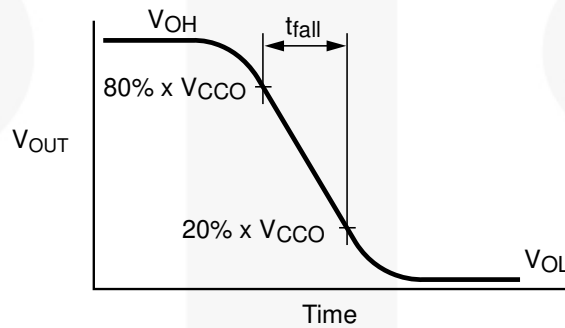
$$I_{OLD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(80\% - 20\%) \bullet V_{CCO}}{t_{FALL}}$$

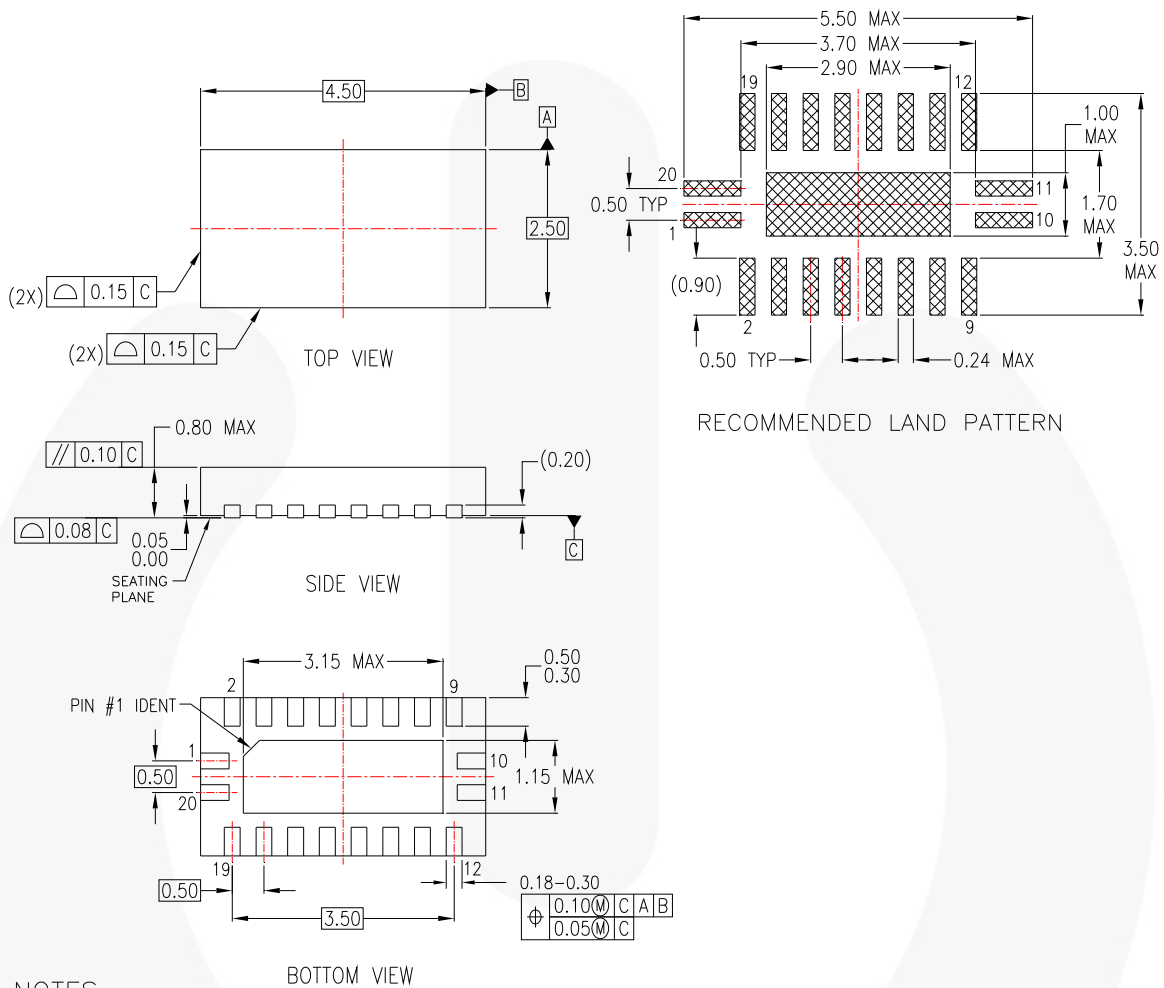**Figure 8.    Active Output Fall Time and Dynamic Output Current Low**

Maximum Data Rate, f = 1/t_W
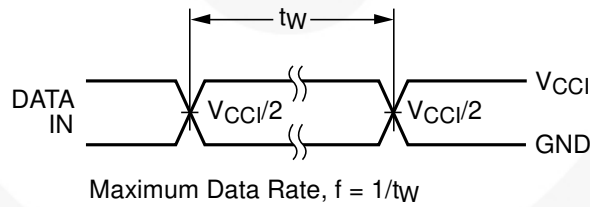
**Figure 9.    Maximum Data Rate**
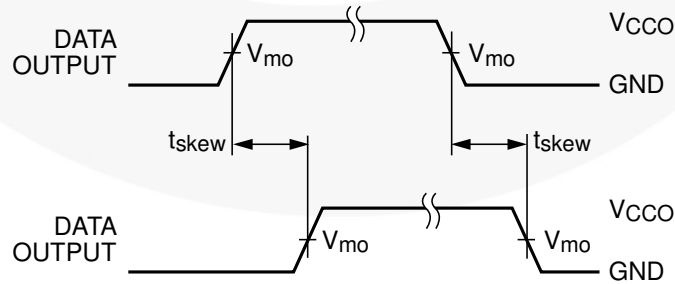
**Figure 10.    Output Skew Time**

**Note:**
   22.  $t_{SKEW} = (t_{pHLmax} - t_{pHLmin})$ or $(t_{pLHmax} - t_{pLHmin})$

## Physical Dimensions

**Figure 11. 20-Terminal DQFN 2.5mm x 4.5mm Package**

NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AC
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP20BrevA

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